



#23 / Supp  
135  
10-25-02  
RSL

PATENT

I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to the Commissioner of Patents, Washington, DC 20231.

October 4, 2002

Date

SLA

Stephanie Jansen

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant : Tongbi Jiang

Attorney Docket No.: 500182.01 (660073.774)

Serial No. : 09/365,356

Group Art Unit : 2813

Filed : July 30, 1999

Examiner : Nema O. Berezny

Title : METHOD AND STRUCTURE FOR MANUFACTURING IMPROVED YIELD  
SEMICONDUCTOR PACKAGED DEVICES

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Commissioner of Patents  
Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. §§ 1.56 and 1.97 through 1.98, applicant wishes to make known to the Patent and Trademark Office the reference set forth on the attached form PTO-1449 (a copy of the cited reference, as required under 37 C.F.R. § 1.98, is enclosed). Although the aforesaid reference is made known to the Patent and Trademark Office in compliance with applicant's duty to disclose all information he is aware of which is believed relevant to the examination of the above-identified application, applicant believes that his invention is patentable.

Applicant also wishes to make known to the Patent and Trademark Office that applications, Serial Nos. 09/681,839 and 10/041,322, describing and claiming subject matter that are similar to the subject matter of this application, were filed on July 26, 2001, and January 7, 2002, respectively. These related applications, which are divisionals of above-referenced Application No. 09/365,536, filed July 30, 1999, as well as any prior art cited therein, may be material to the examination of this application. The specification, claims, abstract and

RECEIVED  
OCT 23 2002  
RECEIVED  
OCT 17 2002  
TECHNOLOGY CENTER 2800

drawings of these related applications as filed are identical to those currently on file in the instant application as filed, therefore duplicate copies are not submitted herewith.

I hereby certify that no item set forth on the attached form PTO-1449 was cited in a communication from a foreign patent office in a counterpart foreign application or, to my knowledge, after making reasonable inquiry, was known to any individual designated in 37 C.F.R. § 1.56(c) more than three months prior to the filing of this Supplemental Information Disclosure Statement.

Please acknowledge receipt of this Supplemental Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

Respectfully submitted,

DORSEY & WHITNEY LLP



Steven H. Arterberry  
Registration No. 46,314

SHA:sj

Enclosures:

Postcard  
Form PTO-1449  
Cited Reference (1)

1420 Fifth Avenue, Suite 3400  
Seattle, WA 98101  
Telephone (206) 903-8800  
Facsimile (206) 903-8820